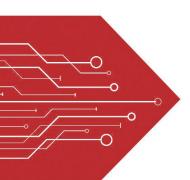
MSKSEMI















ESD

TVS

TSS

MOV

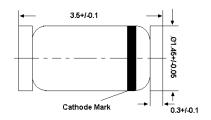
GDT

PLED

Brodnet data speet

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Characteristics equivalent to or better than 1N60P ideal for used in detection or for switching on the radio, TV, etc.



Glass case MiniMELF
Dimensions in mm

LL-34

REEL SPECIFICATION

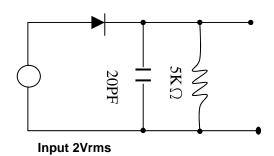
P/N	PKG	QTY
LL60P	LL34	2500

Absolute Maximum Ratings (T_a = 25 °C)

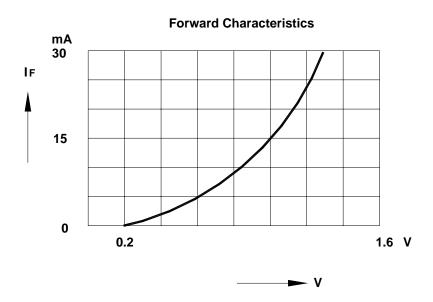
Parameter	Symbol	Value	Unit	
Peak Reverse Voltage	V_{RM}	45	V	
Reverse Voltage	V _R	V _R 20		
Average Rectified Output Current	I _O	50	mA	
Peak Forward Current	I _{FM}	150	mA	
Surge Forward Current	I _{surge}	500	mA	
Junction Temperature	T _j	125	°C	
Storage Temperature Range	T_{stg}	- 55 to + 150	°C	

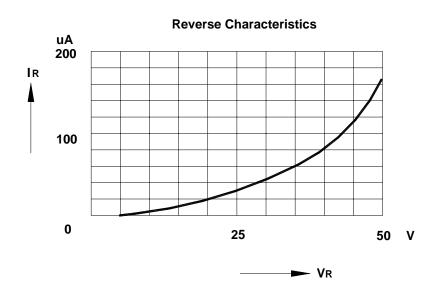
Characteristics at T_a = 25 °C

Parameter	Symbol	Min.	Max.	Unit
Forward Current at V _F = 1 V	I _F	4	-	mA
Reverse Current at V _R = 10 V	I _R	-	50	μΑ
Total Capacitance At V = -1 V, f = 1 MHz	C _{tot}	-	1	pF
Rectification efficiency at Vi = 2 Vrms, R = 5 K Ω	η	55	-	%



Rectification Efficiency Measurement Circuit







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